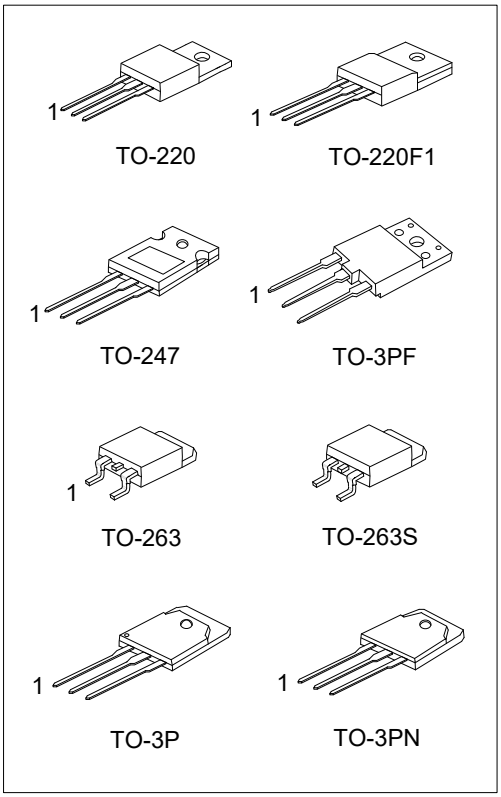
3N150-E3

Power MOSFET

3.0A, 1500V N-CHANNEL POWER MOSFET



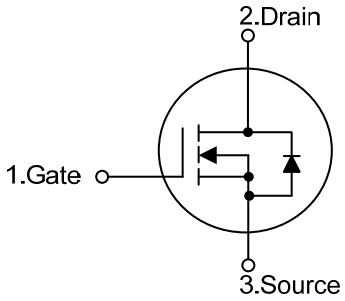
■ DESCRIPTION

The UTC **3N150-E3** provide excellent $R_{DS(ON)}$, low gate charge and operation with low gate voltages. This device is suitable for use as a load switch or in PWM applications.

■ FEATURES0

* $R_{DS(ON)} \leq 7.5\ \Omega$ @ V_{GS}=10V, I_D=1.5A
* Low Reverse Transfer Capacitance
* Fast Switching Capability
* Avalanche Energy Specified
* Improved dv/dt Capability, High Ruggedness

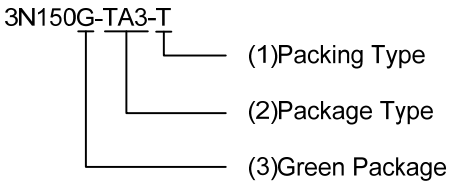
■ SYMBOL



■ ORDERING INFORMATION

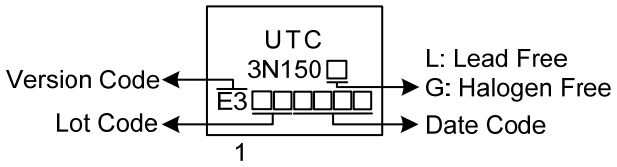
Ordering Number		Package	Pin Assignment			Packing
Lead Free	Halogen Free		1	2	3	
3N150L-TA3-T	3N150G-TA3-T	TO-220	G	D	S	Tube
3N150L-TF1-T	3N150G-TF1-T	TO-220F1	G	D	S	Tube
3N150L-TQ2-T	3N150G-TQ2-T	TO-263	G	D	S	Tube
3N150L-TQ2-R	3N150G-TQ2-R	TO-263	G	D	S	Tape Reel
3N150L-TQS-T	3N150G-TQS-T	TO-263S	G	D	S	Tube
3N150L-TQS-R	3N150G-TQS-R	TO-263S	G	D	S	Tape Reel
3N150L-T3F-T	3N150G-T3F-T	TO-3PF	G	D	S	Tube
3N150L-T3N-T	3N150G-T3N-T	TO-3PN	G	D	S	Tube
3N150L-T3P-T	3N150G-T3P-T	TO-3P	G	D	S	Tube
3N150L-T47-T	3N150G-T47-T	TO-247	G	D	S	Tube

Note: Pin Assignment: G: Gate D: Drain S: Source



(1) T: Tube, R: Tape Reel
(2) TA3: TO-220, TF1: TO-220F1, T3F: TO-3PF, T3N: TO-3PN, T3P: TO-3P, TQ2: TO-263, T47: TO-247
(3) G: Halogen Free and Lead Free, L: Lead Free

■ MARKING



■ ABSOLUTE MAXIMUM RATINGS (T_C=25°C, unless otherwise specified)

PARAMETER			SYMBOL	RATINGS	UNIT
Drain-Source Voltage			V_{DSS}	1500	V
Gate-Source Voltage			V_{GSS}	±30	V
Drain Current	Continuous	T_C= 25°C	I_D	3	A
		T_C=100°C		1.8	A
	Pulsed (Note 2)		I_{DM}	6	A
Avalanche Energy	Single Pulsed (Note 3)		E_{AS}	145	mJ
Peak Diode Recovery dv/dt (Note 4)			dv/dt	2.5	V/ns
Power Dissipation	TO-220/TO-263 TO-263S		P_D	78	W
	TO-220F1			18	W
	TO-247			110	W
	TO-3PF			52	W
	TO-3P/TO-3PN			120	W
Junction Temperature			T_J	+150	°C
Storage Temperature			T_{STG}	-55 ~ +150	°C

Notes: 1. Absolute maximum ratings are those values beyond which the device could be permanently damaged. Absolute maximum ratings are stress ratings only and functional device operation is not implied.
2. Repetitive Rating: Pulse width limited by maximum junction temperature.
3. L = 30mH, I_{AS} = 3.1A, V_{DD} = 90V, R_G = 25Ω, Starting T_J = 25°C
4. I_{SD} ≤ 3.0A, di/dt ≤ 200A/μs, V_{DD} ≤ BV_{DSS}, Starting T_J = 25°C

■ THERMAL DATA

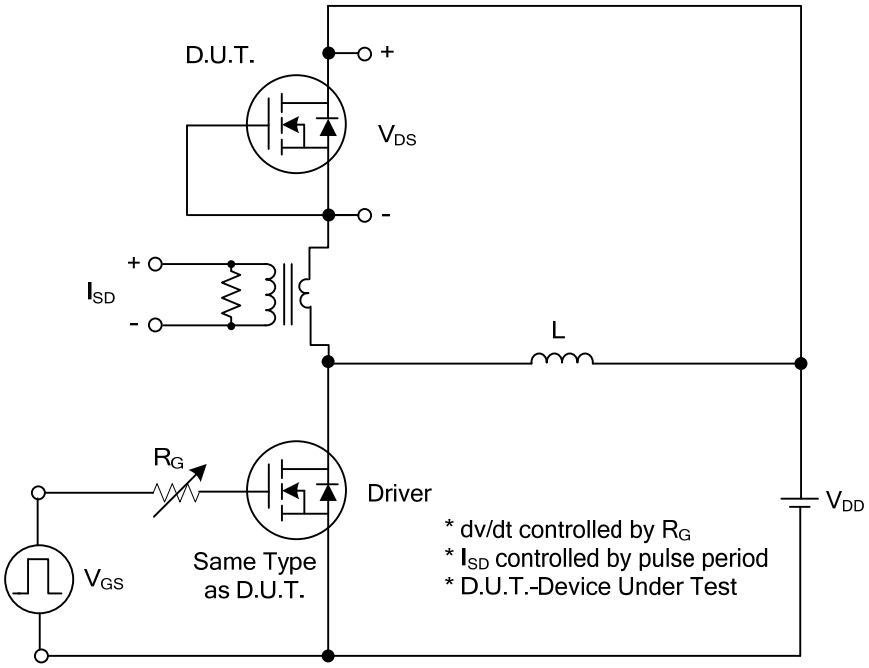
PARAMETER		SYMBOL	RATING	UNIT
Junction to Ambient	TO-220/TO-220F1 TO-263/TO-263S	θ_{JA}	62.5	°C/W
	TO-247		50	°C/W
	TO-3PF/TO-3PN TO-3P			°C/W
Junction to Case	TO-220/TO-263 TO-263S	θ_{JC}	1.6	°C/W
	TO-220F1		6.94	°C/W
	TO-247		1.13	°C/W
	TO-3PF		2.4	°C/W
	TO-3P/TO-3PN		1.04	°C/W

■ ELECTRICAL CHARACTERISTICS (T_J=25°C, unless otherwise specified)

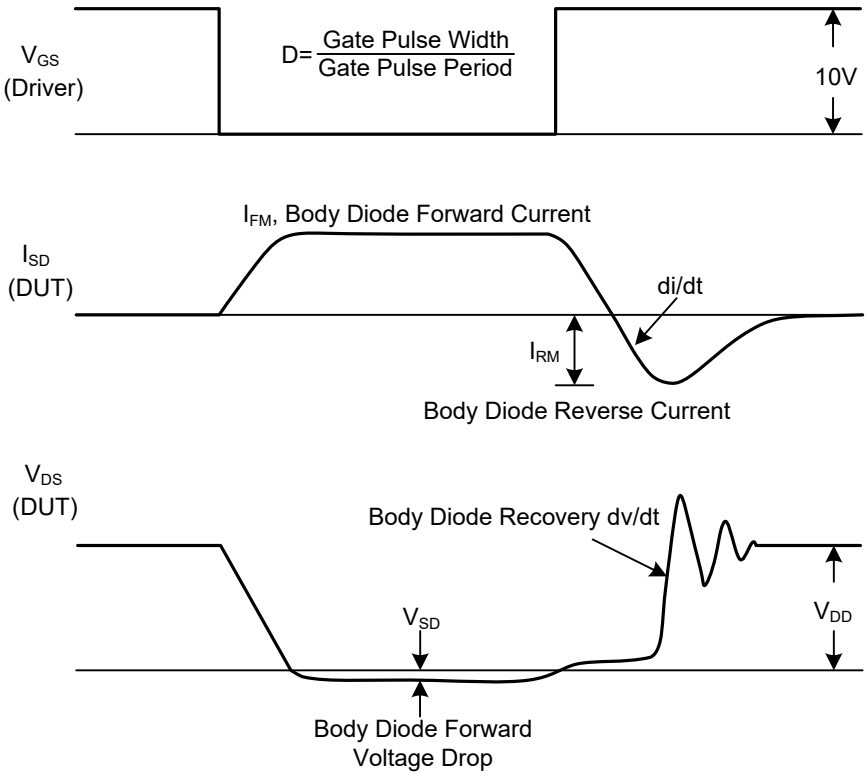
PARAMETER	SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNIT
OFF CHARACTERISTICS						
Drain-Source Breakdown Voltage	BV_{DSS}	V_{GS}=0V, I_D=250μA	1500			V
Drain-Source Leakage Current	I_{DSS}	V_{DS}=1500V, V_{GS}=0V			10	μA
Gate-Source Leakage Current	I_{GSS}	V_{GS}=±30V, V_{DS}=0V			±100	nA
ON CHARACTERISTICS						
Gate Threshold Voltage	$V_{GS(TH)}$	V_{DS}=V_{GS}, I_D=250μA	3.0		5.0	V
Static Drain-Source On-State Resistance	$R_{DS(ON)}$	V_{GS}=10V, I_D=1.5A			7.5	Ω
DYNAMIC CHARACTERISTICS						
Input Capacitance	C_{ISS}	V_{DS}=25V, V_{GS}=0V, f=1MHz		981		pF
Output Capacitance	C_{OSS}			74		pF
Reverse Transfer Capacitance	C_{RSS}			15		pF
SWITCHING CHARACTERISTICS						
Total Gate Charge (Note 1)	Q_G	V_{DS}=1200V, V_{GS}=10V, I_D=3.0A (Note 1, 2)		39		nC
Gate-Source Charge	Q_{GS}			12.8		nC
Gate-Drain Charge	Q_{GD}			12.4		nC
Turn-On Delay Time (Note 1)	$t_{D(ON)}$	V_{DD}=100V, V_{GS}=10V, I_D=3.0A, R_G=25Ω (Note 1, 2)		16		ns
Turn-On Rise Time	t_R			24		ns
Turn-Off Delay Time	$t_{D(OFF)}$			104		ns
Turn-Off Fall Time	t_F			51		ns
SOURCE- DRAIN DIODE RATINGS AND CHARACTERISTICS						
Maximum Continuous Drain-Source Diode Forward Current	I_S				3	A
Maximum Pulsed Drain-Source Diode Forward Current	I_{SM}				6	A
Drain-Source Diode Forward Voltage (Note 1)	V_{SD}	I_S=3.0A, V_{GS}=0V			1.4	V
Body Diode Reverse Recovery Time (Note 1)	t_{rr}	I_S=3.0A, V_{GS}=0V, dI_F/dt=100A/μs		0.63		μS
Body Diode Reverse Recovery Charge	Q_{rr}			6.1		μC

Notes: 1. Pulse Test: Pulse width ≤ 300μs, Duty cycle ≤ 2%.
2. Essentially independent of operating temperature.

■ TEST CIRCUITS AND WAVEFORMS

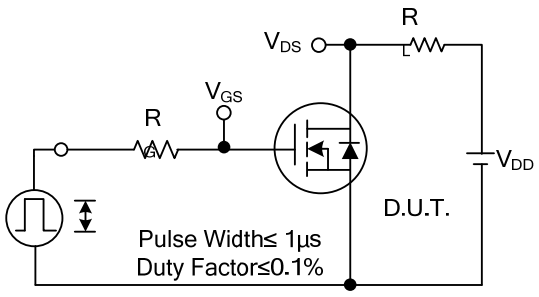


Peak Diode Recovery dv/dt Test Circuit

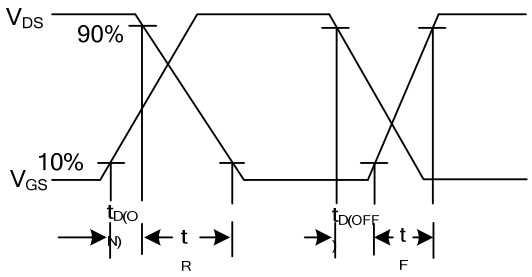


Peak Diode Recovery dv/dt Waveforms

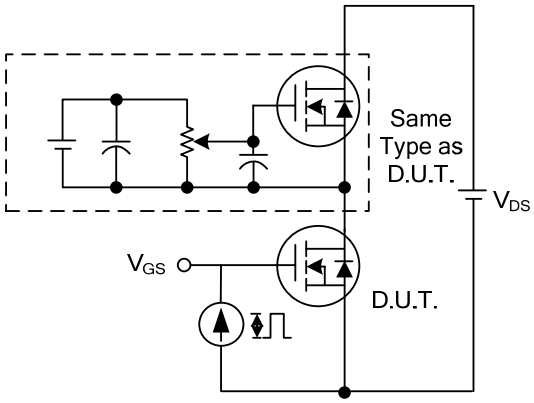
■ TEST CIRCUITS AND WAVEFORMS



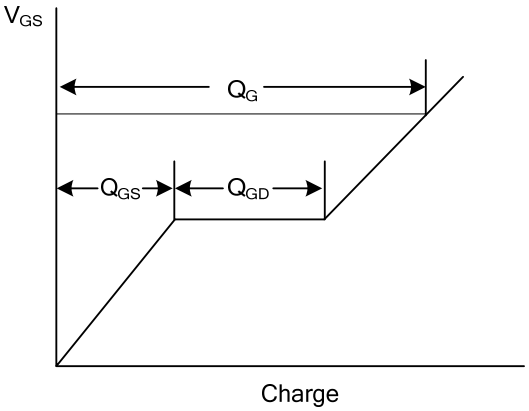
Switching Test Circuit



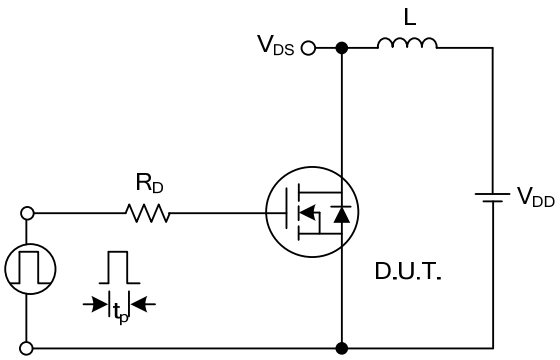
Switching Waveforms



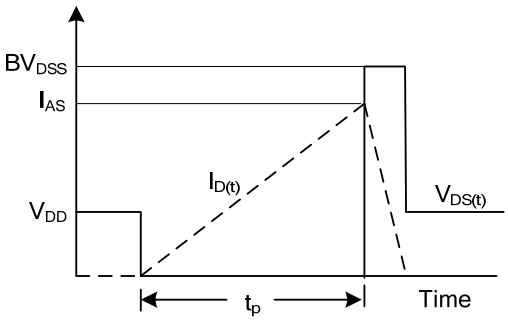
Gate Charge Test Circuit



Gate Charge Waveform



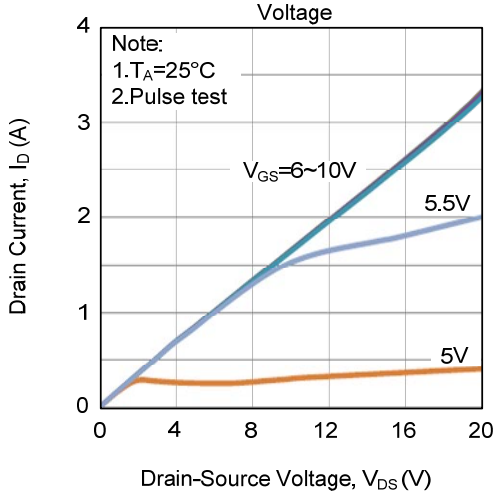
Unclamped Inductive Switching Test Circuit



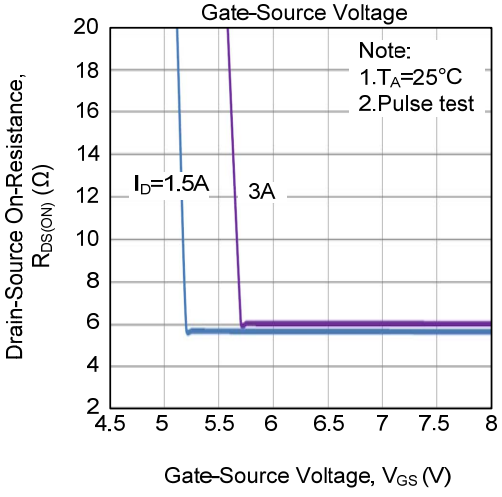
Unclamped Inductive Switching Waveforms

■ TYPICAL CHARACTERISTICS

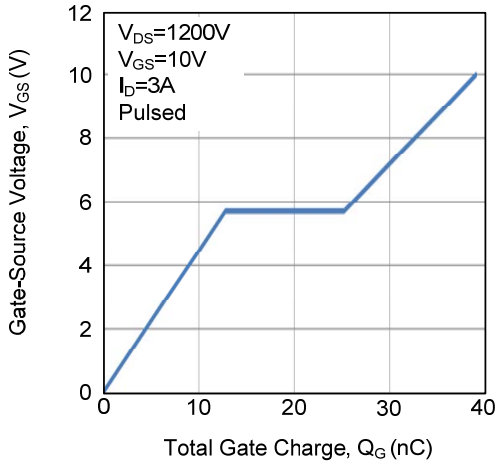
Drain Current vs. Drain-Source Voltage



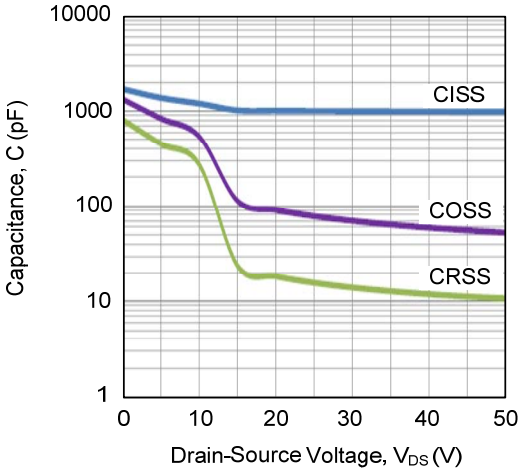
Drain-Source On-Resistance vs. Gate-Source Voltage



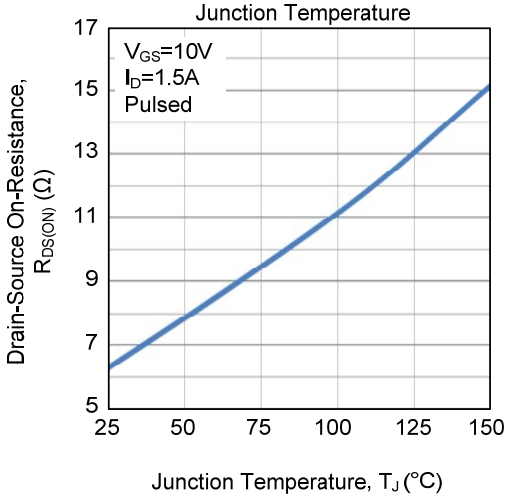
Gate Charge Characteristics



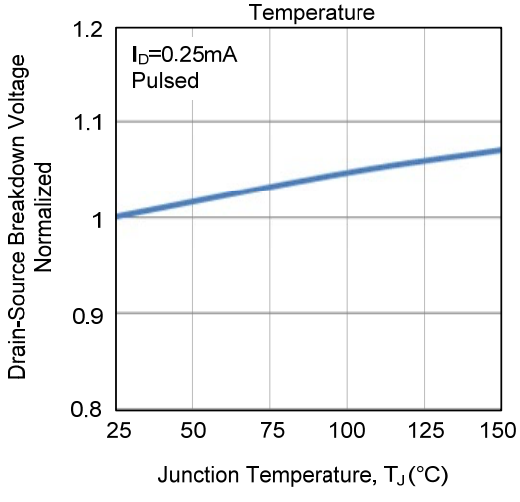
Capacitance Characteristics



Drain-Source On-Resistance vs. Junction Temperature

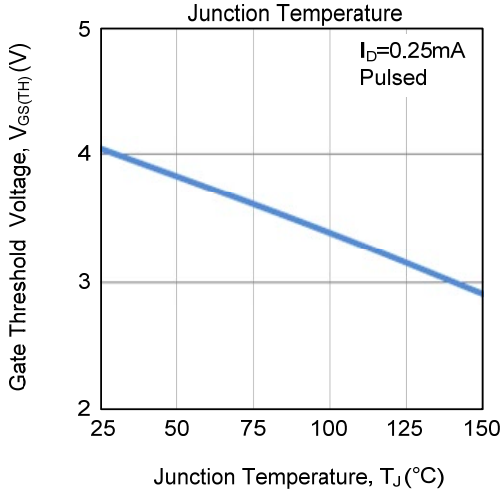


Breakdown Voltage vs. Junction Temperature

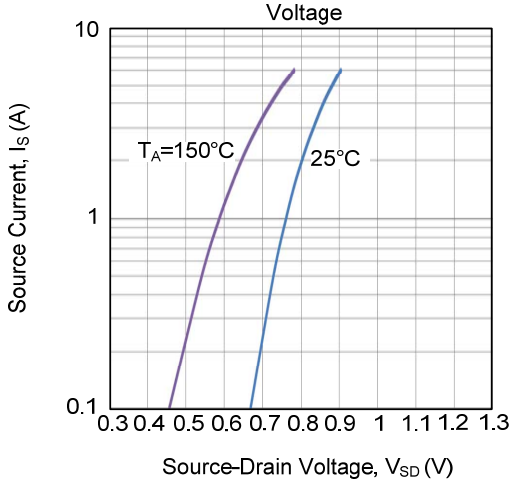


■ TYPICAL CHARACTERISTICS (Cont.)

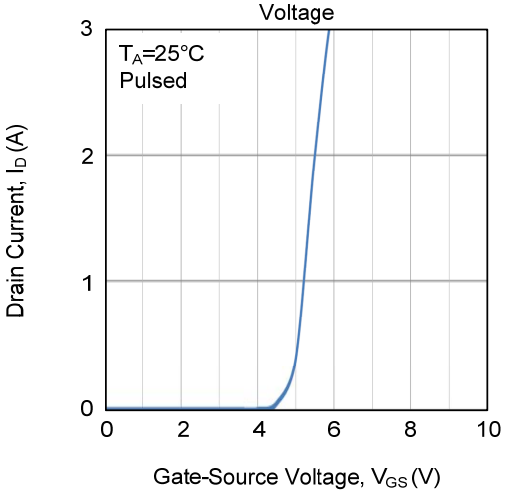
Gate Threshold Voltage vs. Junction Temperature



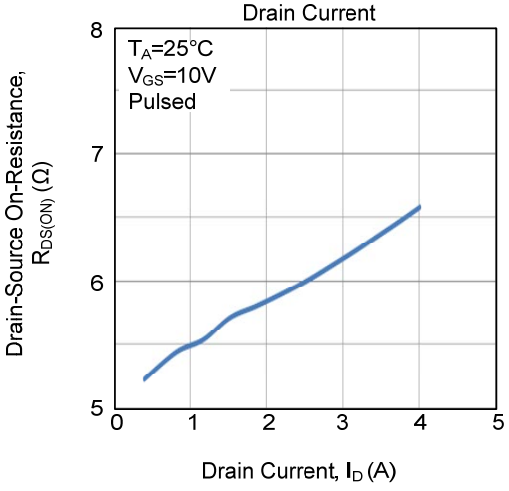
Source Current vs. Source-Drain Voltage



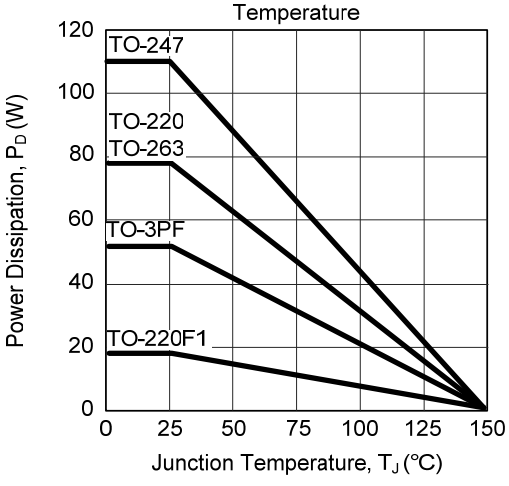
Drain Current vs. Gate-Source Voltage



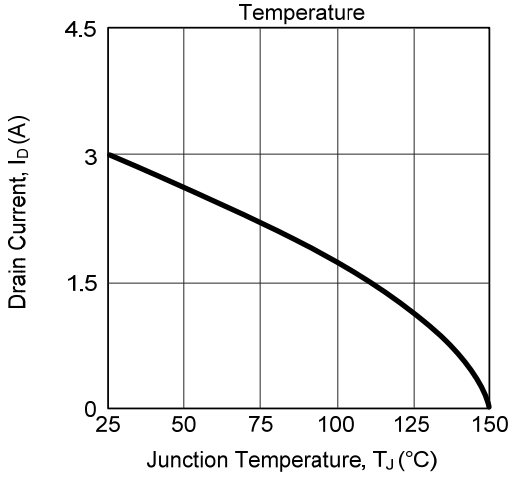
Drain-Source On-Resistance vs. Drain Current



Power Dissipation vs. Junction Temperature



Drain Current vs. Junction Temperature



■ TYPICAL CHARACTERISTICS (Cont.)